1-Bit 20 Mb/s Dual-Supply Level Translator

The NLSX4401 is a 1-bit configurable dual-supply bidirectional auto sensing translator that does not require a directional control pin. The I/O V_{CC} and I/O V_L ports are designed to track two different power supply rails, V_{CC} and V_L respectively. Both the V_{CC} and V_L supply rails are configurable from 1.5 V to 5.5 V. This allows voltage logic signals on the V_L signals on the V_{CC} side, and vice-versa.

The NLSX4401 translator has integrated 10 k Ω pull–up resistors on the I/O lines. The integrated pull–up resistors are used to pull up the I/O lines to either V_L or V_{CC} . The NLSX4401 is an excellent match for open–drain applications such as the I^2C communication bus.

Features

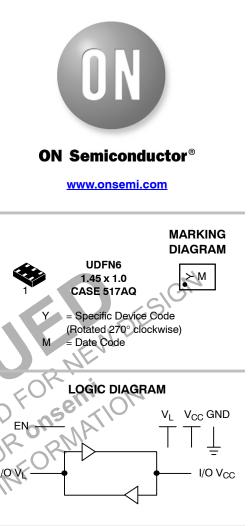
- V_L can be Less than, Greater than or Equal to V_{CC}
- Wide V_{CC} Operating Range: 1.5 V to 5.5 V Wide V_L Operating Range: 1.5 V to 5.5 V
- High Speed with 24 Mb/s Guaranteed Date Rate
- Low Bit-to-Bit Skew
- Enable Input and I/O Pins are Overvoltage Tolerant (OVT) to 5:5 V
- Non-preferential Powerup Sequencing
- Power-Off Protection
- Integrated 10 k Ω Pull-up Resistors
- Small Space Saving Package:
 - 1.45 mm x 1.0 mm UDFN6 Package
- These Devices are Pb-Free and are RoHS Compliant

Typical Applications

- I²C, SMBus, PMBus
- Low Voltage ASIC Level Translation
- Mobile Phones, PDAs, Cameras

Important Information

- ESD Protection for All Pins
 - Human Body Model (HBM) > 5000 V

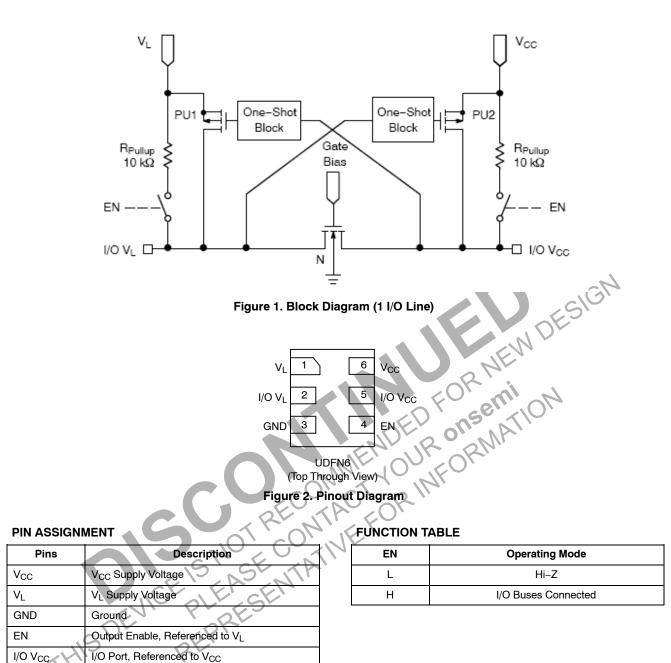


ORDERING INFORMATION

Device	Package	Shipping [†]
NLSX4401MU1TCG	UDFN6 (Pb–Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

JEFOR



I/O VL

I/O Port, Referenced to VL

MAXIMUM RATINGS

Symbol	Parameter	Value	Condition	Unit
V _{CC}	High-side DC Supply Voltage	-0.5 to +7.0		V
VL	High-side DC Supply Voltage	-0.5 to +7.0		V
I/O V _{CC}	V _{CC} -Referenced DC Input/Output Voltage	-0.5 to +7.0		V
I/O V _L	V _L -Referenced DC Input/Output Voltage	-0.5 to +7.0		V
V_{EN}	Enable Control Pin DC Input Voltage	-0.5 to +7.0		V
I _{I/O_SC}	Short–Circuit Duration (I/O V_L and I/O V_{CC} to GND)	±50	Continuous	mA
I _{I/OK}	Input/Output Clamping Current (I/O $\rm V_L$ and I/O $\rm V_{CC})$	-50	V _{I/O} < 0	mA
T _{STG}	Storage Temperature	-65 to +150		°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

-2

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V _{CC}	High-side Positive DC Supply Voltage	1.5	5.5	V
VL	High-side Positive DC Supply Voltage	1,5	5.5	V
V_{EN}	Enable Control Pin Voltage	GND	5.5	V
V _{IO_VCC}	I/O Pin Voltage (Side referred to V _{CC})	GND	5.5	V
V _{IO_VL}	I/O Pin Voltage (Side referred to VL)	GND	5.5	V
$\Delta t/\Delta V$	Input Transition Rise and Fall Rate A- or B-Ports, Push-Pull Driving Control Input	MATT	10 10	ns/V
T _A nctional op commende	Operating Temperature Range peration above the stresses listed in the Recommended Operating Ranges is not implied. If ad Operating Ranges limits may affect device reliability.	-55 Extended expo	+125 osure to stresses	°C beyond

			–55°C to +125°C			
Symbol	Parameter	Test Conditions (Note 2)	Min	Тур	Max	Unit
V _{IHC}	I/O V _{CC} Input HIGH Voltage		$V_{CC} - 0.4$	-	_	V
VILC	I/O V _{CC} Input LOW Voltage		-	-	0.15	V
VIHL	I/O VL Input HIGH Voltage		$V_{L} - 0.4$	-	-	V
V _{ILL}	I/O VL Input LOW Voltage		-	-	0.15	V
V _{IH}	Control Pin Input HIGH Voltage		0.65 * V _L	-	-	V
VIL	Control Pin Input LOW Voltage		-	-	0.35 * V _L	V
V _{OHC}	I/O Vcc Output HIGH Voltage	I/O V _{CC} source current = 20 μA	2/3 * V _{CC}	-	-	V
V _{OLC}	I/O Vcc Output LOW Voltage	I/O V _{CC} sink current = 1 mA	-	-	0.4	V
V _{OHL}	I/O V∟Output HIGH Voltage	I/O V _L source current = 20 μ A	2/3 * V _L	-	-	V
V _{OLL}	I/O V₋Output LOW Voltage	I/O V _L sink current = 1 mA		_	0.4	V
IQVCC	V _{CC} Supply Current Supply Current	I/O V _{CC} and I/O V _L unconnected, V _{EN} = V _L V _L = 5.5 V, V _{CC} = 0 V V _L = 0 V, V _{CC} = 5.5 V	-	0.5	2.0 1.0 -1.0	μΑ
I _{QVL}	V _⊾ Supply Current Supply Current	I/O V _{CC} and I/O V _L unconnected, V _{EN} = V _L V _L = 5.5 V, V _{CC} = 0 V V _L = 0 V, V _{CC} = 5.5 V	NE	0.3 - -	1.5 -1.0 1.0	μΑ
I _{TS-VCC}	V _{CC} Tristate Output Mode	I/O V _{CC} and I/O V _L unconnected, V _{EN} = GND	10-	0.1	1.0	μA
I _{TS-VL}	V _L Tristate Output Mode Supply Cur- rent	I/O V _{CC} and I/O V _L unconnected, V _{EN} = GND	ISEMI	0.1	1.0	μΑ
l _l	Enable Pin Input Leakage Current	CNV IR	2NII	-	1.0	μA
I _{OFF}	I/O Power-Off Leakage Current	I/O V _{CC} Port, V _{CC} = 0 V, V _L = 0 to 5.5 V I/O VL Port, VCC = 0 to 5.5 V, V _L = 0 V	-	-	1.0 1.0	μΑ
I _{OZ}	I/O Tristate Output Mode Leakage Current	RENTACEOR	-	0.1	1.0	μA
R _{PU}	Pull–Up Resistors I/O V_L and V_C	COTIVE	_	10	-	kΩ

DC ELECTRICAL CHARACTERISTICS (V_L = 1.5 V to 5.5 V and V_{CC} = 1.5 V to 5.5 V, unless otherwise specified) (Note 1)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 1. Typical values are for $V_L = +1.8 \text{ V}$, $V_{CC} = +3.3 \text{ V}$ and $T_A = +25^{\circ}\text{C}$. 2. All units are production tested at $T_A = +25^{\circ}\text{C}$. Limits over the operating temperature range are guaranteed by design.

TIMING CHARACTERISTICS - RAIL-TO-RAIL DRIVING CONFIGURATIONS

(I/O test circuit of Figures 3 and 4, C_{LOAD} = 15 pF, driver output impedance \leq 50 Ω , R_{LOAD} = 1 M Ω)

			- 40°C to +85°C (Notes 3 & 4)			
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V _L = 1.5 V, V	V _{CC} = 1.5 V					
t _{RVCC}	I/O V _{CC} Rise Time			9	32	ns
t _{FVCC}	I/O V _{CC} Fall Time			11	20	ns
t _{RVL}	I/O V _L Rise Time			20	30	ns
t _{FVL}	I/O V _L Fall Time			10	13	ns
t _{PDVL-VCC}	Propagation Delay (Driving I/O V_L , V_L to V_{CC})			7	16	ns
t _{PDVCC-VL}	Propagation Delay (Driving I/O V_{CC} , V_{CC} to V_L)			12	15	ns
t _{EN}	Enable Time				50	ns
t _{DIS}	Disable Time				300	ns
t PPSKEW	Part-to-Part Skew				2	ns
MDR	Maximum Data Rate		15	, OF		Mbps
V _L = 1.5 V, V	V _{CC} = 5.5 V			N		
t _{RVCC}	I/O V _{CC} Rise Time		4r	9	12	ns
t _{FVCC}	I/O V _{CC} Fall Time		in i	17	30	ns
t _{RVL}	I/O V _L Rise Time		e	2	4	ns
t _{FVL}	I/O V _L Fall Time	OF ON	An.	3	7	ns
t _{PDVL-VCC}	Propagation Delay (Driving I/O V_L , V_L to V_{CC})	NUK A	5/2	14	24	ns
t _{PDVCC-VL}	Propagation Delay (Driving I/O V_{CC} , V_{CC} to V_{L})	105 FO		3	5	ns
t _{EN}	Enable Time	2			40	ns
t _{DIS}	Disable Time	COL.			250	ns
t _{PPSKEW}	Part-to-Part Skew				2	ns
MDR	Maximum Data Rate		20			Mbps
V _L = 1.8 V, V	V _{CC} = 2.8 V					
t _{RVCC}	I/O V _{CC} Rise Time			11	18	ns
t _{FVCC}	I/O V _{CC} Fall Time			10	15	ns
t _{RVL}	I/O V _L Rise Time			12	15	ns
t _{FVL}	NO V _L Fall Time			5	8	ns
t _{PDVL-VCC}	Propagation Delay (Driving I/O V_L , V_L to V_{CC})			7	10	ns
t _{PDVCC-VL}	Propagation Delay (Driving I/O V_{CC},V_{CC} to $V_L)$			5	9	ns
t _{EN}	Enable Time				50	ns
t _{DIS}	Disable Time				300	ns
t PPSKEW	Part-to-Part Skew				2	ns
MDR	Maximum Data Rate		20			Mbps

I/O V_{CC} Rise Time t_{RVCC} 8 12 ns Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product perfor-

mance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Typical values are for the specified V_L and V_{CC} at $T_A = +25^{\circ}C$. All units are production tested at $T_A = +25^{\circ}C$. 4. Limits over the operating temperature range are guaranteed by design.

5. Skew is the variation of propagation delay between output signals and applies only to output signals on the same port (I/O VLn or I/O VCCn) and switching with the same polarity (LOW-to-HIGH or HIGH-to-LOW). Skew is defined by applying a single input to the two input channels and measuring the difference in propagation delays between the output channels.

TIMING CHARACTERISTICS - RAIL-TO-RAIL DRIVING CONFIGURATIONS (continued)

(I/O test circuit of Figures 3 and 4, C_{LOAD} = 15 pF, driver output impedance \leq 50 Ω , R_{LOAD} = 1 M Ω)

				- 40°C to +85°C (Notes 3 & 4)		
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V _L = 2.5 V, V	_{CC} = 3.6 V		•			
t _{FVCC}	I/O V _{CC} Fall Time			8	12	ns
t _{RVL}	I/O V _L Rise Time			7	10	ns
t _{FVL}	I/O V _L Fall Time			5	7	ns
t _{PDVL-VCC}	Propagation Delay (Driving I/O V_L , V_L to V_{CC})			7	10	ns
t _{PDVCC-VL}	Propagation Delay (Driving I/O V_{CC} , V_{CC} to V_L)			5	8	ns
t _{EN}	Enable Time				40	ns
t _{DIS}	Disable Time				225	ns
t _{PPSKEW}	Part-to-Part Skew				2	ns
MDR	Maximum Data Rate		24		310	Mbp
V _L = 2.8 V, V	Ccc = 1.8 V			OF		
t _{RVCC}	I/O V _{CC} Rise Time			13	20	ns
t _{FVCC}	I/O V _{CC} Fall Time		NF	7	10	ns
t _{RVL}	I/O V _L Rise Time		in 1	8	13	ns
t _{FVL}	I/O V _L Fall Time		e	9	15	ns
t _{PDVL-VCC}	Propagation Delay (Driving I/O V_L , V_L to V_{CC})	DEL ON	An.	6	9	ns
t _{PDVCC-VL}	Propagation Delay (Driving I/O V_{CC} , V_{CC} to V_L)	NIR	2/11.	7	12	ns
t _{EN}	Enable Time	10,40			60	ns
t _{DIS}	Disable Time				250	ns
t_{PPSKEW}	Part-to-Part Skew	201			2	ns
MDR	Maximum Data Rate	, ·	24			Mbp
V _L = 3.6 V, V	cc = 2.5 V		•			
t _{RVCC}	I/O V _{CC} Rise Time			9	12	ns
t _{FVCC}	I/O V _{CC} Fall Time			6	9	ns
t _{RVL}	I/O V _L Rise Time			6	12	ns
t _{FVL}	I/O V _L Fall Time			7	12	ns
tPDVL-VCC	Propagation Delay (Driving I/O V_L , V_L to V_{CC})			5	7	ns
tPDVCC-VL	Propagation Delay (Driving I/O V_{CC} , V_{CC} to V_L)			6	9	ns
t _{EN}	Enable Time				50	ns
t _{DIS}	Disable Time				250	ns
t PPSKEW	Part-to-Part Skew				2	ns
MDR	Maximum Data Rate		24			Mbp
/ _L = 5.5 V, V	_{CC} = 1.5 V					•
t _{RVCC}	I/O V _{CC} Rise Time			13	20	ns
t _{FVCC}	I/O V _{CC} Fall Time			6	9	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Typical values are for the specified V_L and V_{CC} at $T_A = +25^{\circ}C$. All units are production tested at $T_A = +25^{\circ}C$. 4. Limits over the operating temperature range are guaranteed by design.

5. Skew is the variation of propagation delay between output signals and applies only to output signals on the same port (I/O VLn or I/O VCCn) and switching with the same polarity (LOW-to-HIGH or HIGH-to-LOW). Skew is defined by applying a single input to the two input channels and measuring the difference in propagation delays between the output channels.

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TIMING CHARACTERISTICS - RAIL-TO-RAIL DRIVING CONFIGURATIONS (continued)

(I/O test circuit of Figures 3 and 4, C_{LOAD} = 15 pF, driver output impedance \leq 50 Ω , R_{LOAD} = 1 M Ω)

			-40°C to +8 (Notes 3 &				
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit	
V _L = 5.5 V, V	V _{CC} = 1.5 V						
t _{RVL}	I/O V _L Rise Time			8	10	ns	
t _{FVL}	I/O V _L Fall Time			20	27	ns	
t _{PDVL-VCC}	Propagation Delay (Driving I/O V_L , V_L to V_{CC})			5	8	ns	
t _{PDVCC-VL}	Propagation Delay (Driving I/O V_{CC} , V_{CC} to V_L)			14	24	ns	
t _{EN}	Enable Time					ns	
t _{DIS}	Disable Time					ns	
t _{PPSKEW}	Part-to-Part Skew				2	ns	
MDR	Maximum Data Rate		20		CN.	Mbps	
V _L = 5.5 V, V	V _{CC} = 5.5 V				30		
t _{RVCC}	I/O V _{CC} Rise Time			5	7	ns	
t _{FVCC}	I/O V _{CC} Fall Time			6	8	ns	
t _{RVL}	I/O V _L Rise Time		Hr.	5	7	ns	
t _{FVL}	I/O V _L Fall Time	<u> </u>	in 1	4	7	ns	
t _{PDVL-VCC}	Propagation Delay (Driving I/O V_L , V_L to V_{CC})		e	4	6	ns	
t _{PDVCC-VL}	Propagation Delay (Driving I/O V_{CC} , V_{CC} to V_L)	OF ON	An.	4	6	ns	
t _{EN}	Enable Time	RUK	5/41.		30	ns	
t _{DIS}	Disable Time	10,100			225	ns	
t _{PPSKEW}	Part-to-Part Skew	C'lla.			2	ns	
MDR	Maximum Data Rate	101	24			Mbps	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions, different conditions, 3. Typical values are for the specified V_L and V_{CC} at $T_A = +25^{\circ}$ C. All units are production tested at $T_A = +25^{\circ}$ C. 4. Limits over the operating temperature range are guaranteed by design.

5. Skew is the variation of propagation delay between output signals and applies only to output signals on the same port (I/O_VLn or I/O_VCCn) and switching with the same polarity (LOW-to-HIGH or HIGH-to-LOW). Skew is defined by applying a single input to the two input channels and measuring the difference in propagation delays between the output channels.

TIMING CHARACTERISTICS - OPEN DRAIN DRIVING CONFIGURATIONS

(I/O test circuit of Figures 5 and 6, $C_{LOAD} = 15 \text{ pF}$, driver output impedance $\leq 50 \Omega$, $R_{LOAD} = 1 \text{ M}\Omega$)

			-40°C to +85°C (Notes 6 & 7)			
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V _L = 1.5 V, V	V _{CC} = 1.5 V	•				
t _{RVCC}	I/O V _{CC} Rise Time			55	70	ns
t _{FVCC}	I/O V _{CC} Fall Time			7	14	ns
t _{RVL}	I/O V _L Rise Time			50	65	ns
t _{FVL}	I/O V _L Fall Time			7	12	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

6. Typical values are for the specified V_L and V_{CC} at T_A = +25°C. All units are production tested at T_A = +25°C.

Limits over the operating temperature range are guaranteed by design. 7.

8. Skew is the variation of propagation delay between output signals and applies only to output signals on the same port (I/O_VLn or I/O_VCCn) and switching with the same polarity (LOW-to-HIGH or HIGH-to-LOW). Skew is defined by applying a single input to the two input channels and measuring the difference in propagation delays between the output channels.

TIMING CHARACTERISTICS - OPEN DRAIN DRIVING CONFIGURATIONS (continued)

(I/O test circuit of Figures 5 and 6, C_{LOAD} = 15 pF, driver output impedance \leq 50 Ω , R_{LOAD} = 1 M Ω)

			- 40°C to +85°C (Notes 6 & 7)			
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
/ _L = 1.5 V, V	/ _{CC} = 1.5 V					
t _{PDVL-VCC}	Propagation Delay (Driving I/O V_L,V_L to V_{CC})			20	34	ns
t _{PDVCC-VL}	Propagation Delay (Driving I/O V_{CC},V_{CC} to $V_L)$			19	34	ns
t _{EN}	Enable Time				100	ns
t _{DIS}	Disable Time				300	ns
t _{PPSKEW}	Part-to-Part Skew				2	ns
MDR	Maximum Data Rate		3			Mbps
V _L = 1.5 V, V	V _{CC} = 5.5 V	·				
t _{RVCC}	I/O V _{CC} Rise Time			22	34	ns
t _{FVCC}	I/O V _{CC} Fall Time			20	27	ns
t _{RVL}	I/O V _L Rise Time			43	55	ns
t _{FVL}	I/O V _L Fall Time			6	12	ns
t _{PDVL-VCC}	Propagation Delay (Driving I/O V_L , V_L to V_{CC})		Nr	13	26	ns
t _{PDVCC-VL}	Propagation Delay (Driving I/O V_{CC} , V_{CC} to V_L)			19	24	ns
t _{EN}	Enable Time		e	0	80	ns
t _{DIS}	Disable Time	DEL ON	An.		250	ns
t _{PPSKEW}	Part-to-Part Skew	ENLIR	2/11.		2	ns
MDR	Maximum Data Rate	WILLOU FO	3			Mbps
V _L = 1.8 V, V	/ _{CC} = 3.3 V	n CL DILL.	I.	1 1		
t _{RVCC}	I/O V _{CC} Rise Time	(PCCOK		34	40	ns
t _{FVCC}	I/O V _{CC} Fall Time	I.E.Y		1	15	ns
t _{RVL}	I/O VL Rise Time	NY		40	48	ns
t _{FVL}	I/O VL Fall Time			1	2	ns
t _{PDVL-VCC}	Propagation Delay (Driving I/O VL, VL to VCC)			9	15	ns
t _{PDVCC-VL}	Propagation Delay (Driving I/O V _{CC} , V _{CC} to V _L)			6	11	ns
t _{EN}	Enable Time				70	ns
t _{DIS}	Disable Time				300	ns
t _{PPSKEW}	Part-to-Part Skew				2	ns
MDR	Maximum Data Rate		7			Mbps
V _L = 5.5 V, V	/ _{CC} = 1.5 V	Į	Į	<u> </u>		
t _{RVCC}	I/O V _{CC} Rise Time			44	52	ns
t _{FVCC}	I/O V _{CC} Fall Time			1	2	ns
t _{RVL}	I/O V _L Rise Time			7	30	ns
	-					
t _{FVL}	I/O V _L Fall Time			17	23	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

6. Typical values are for the specified V_L and V_{CC} at $T_A = +25^{\circ}C$. All units are production tested at $T_A = +25^{\circ}C$. 7. Limits over the operating temperature range are guaranteed by design.

8. Skew is the variation of propagation delay between output signals and applies only to output signals on the same port (I/O_VLn or I/O_VCCn) and switching with the same polarity (LOW-to-HIGH or HIGH-to-LOW). Skew is defined by applying a single input to the two input channels and measuring the difference in propagation delays between the output channels.

TIMING CHARACTERISTICS - OPEN DRAIN DRIVING CONFIGURATIONS (continued)

(I/O test circuit of Figures 5 and 6, C_{I OAD} = 15 pF, driver output impedance \leq 50 Ω , R_{I OAD} = 1 M Ω)

	Parameter		-40°C to +85°C (Notes 6 & 7)			
Symbol		Test Conditions	Min	Тур	Max	Unit
V _L = 5.5 V, V	/ _{CC} = 1.5 V					
t _{PDVCC-VL}	Propagation Delay (Driving I/O V_{CC} , V_{CC} to V_L)			12	24	ns
t _{EN}	Enable Time				100	ns
t _{DIS}	Disable Time				300	ns
t _{PPSKEW}	Part-to-Part Skew				2	ns
MDR	Maximum Data Rate		3			Mbps
V _L = 5.5 V, V	/ _{CC} = 5.5 V	·				
t _{RVCC}	I/O V _{CC} Rise Time			42	50	ns
t _{FVCC}	I/O V _{CC} Fall Time			2	3	ns
t _{RVL}	I/O V _L Rise Time			44	48	ns
t _{FVL}	I/O V _L Fall Time			2	3	ns
t _{PDVL-VCC}	Propagation Delay (Driving I/O V_L , V_L to V_{CC})			4	6	ns
t _{PDVCC-VL}	Propagation Delay (Driving I/O V_{CC} , V_{CC} to V_L)		Ph	6	9	ns
t _{EN}	Enable Time	20Y	in 1	2	60	ns
t _{DIS}	Disable Time		e	0^{\prime}	225	ns
t _{PPSKEW}	Part-to-Part Skew	DE ON	A	\$ }	2	ns
MDR	Maximum Data Rate	ENIR	2 7			Mbps

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

6. Typical values are for the specified V_L and V_{CC} at T_A = +25°C. All units are production tested at T_A = +25°C. 7. Limits over the operating temperature range are guaranteed by design.

Limits over the operating temperature range are guaranteed by design.
 Skew is the variation of propagation delay between output signals and applies only to output signals on the same port (I/O_VLn or I/O_VCCn) and switching with the same polarity (LOW-to-HIGH or HIGH-to-LOW). Skew is defined by applying a single input to the two input channels and measuring the difference in propagation delays between the output channels.

TEST SETUP

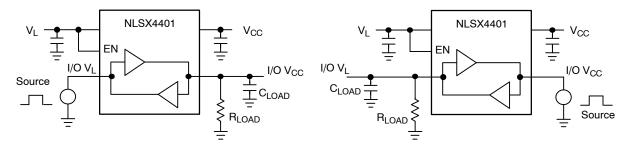




Figure 4. Rail-to-Rail Driving I/O V_{CC}

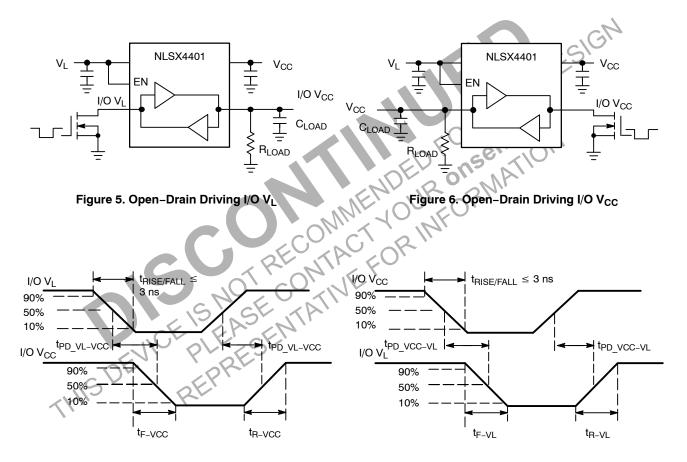
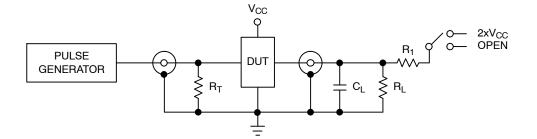


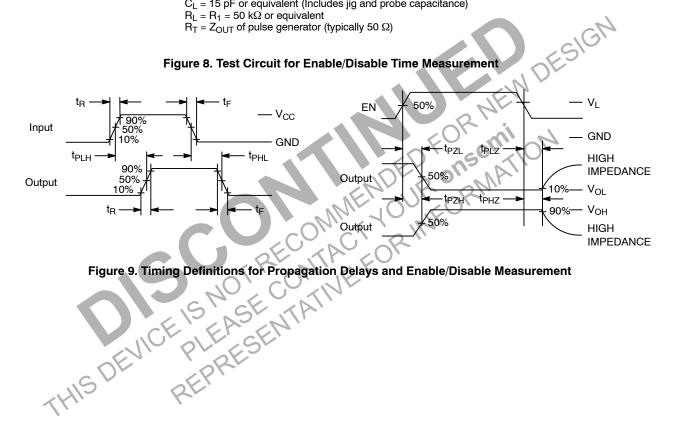
Figure 7. Definition of Timing Specification Parameters



Test	Switch
t _{PZH} , t _{PHZ}	Open
t _{PZL} , t _{PLZ}	$2 \times V_{CC}$

 $C_L = 15 \text{ pF}$ or equivalent (Includes jig and probe capacitance) $R_L = R_1 = 50 \text{ k}\Omega$ or equivalent

 $R_T = Z_{OUT}$ of pulse generator (typically 50 Ω)



APPLICATIONS INFORMATION

Level Translator Architecture

The NLSX4401 auto sense translator provides bi-directional voltage level shifting to transfer data in multiple supply voltage systems. This device has two supply voltages, V_L and V_{CC} , which set the logic levels on the input and output sides of the translator. When used to transfer data from the I/O V_L to the I/O V_{CC} ports, input signals referenced to the V_L supply are translated to output signals with a logic level matched to V_{CC} . In a similar manner, the I/O V_{CC} to I/O V_L translation shifts input signals with a logic level compatible to V_{CC} to an output signal matched to V_L .

The NLSX4401 consists of two bi-directional channels that independently determine the direction of the data flow without requiring a directional pin. The one-shot circuits are used to detect the rising or falling input signals. In addition, the one shots decrease the rise and fall time of the output signal for high-to-low and low-to-high transitions.

Each input/output channel has an internal 10 k Ω pull-up. The magnitude of the pull-up resistors can be reduced by connecting external resistors in parallel to the internal 10 k Ω resistors.

Input Driver Requirements

The rise (t_R) and fall (t_F) timing parameters of the open drain outputs depend on the magnitude of the pull-up resistors. In addition, the propagation times (t_{PHL} / t_{PLH}), skew (t_{PSKEW}) and maximum data rate depend on the PCB connec

impedance of the device that is connected to the translator. The timing parameters listed in the data sheet assume that the output impedance of the drivers connected to the translator is less than 50 k Ω .

Enable Input (EN)

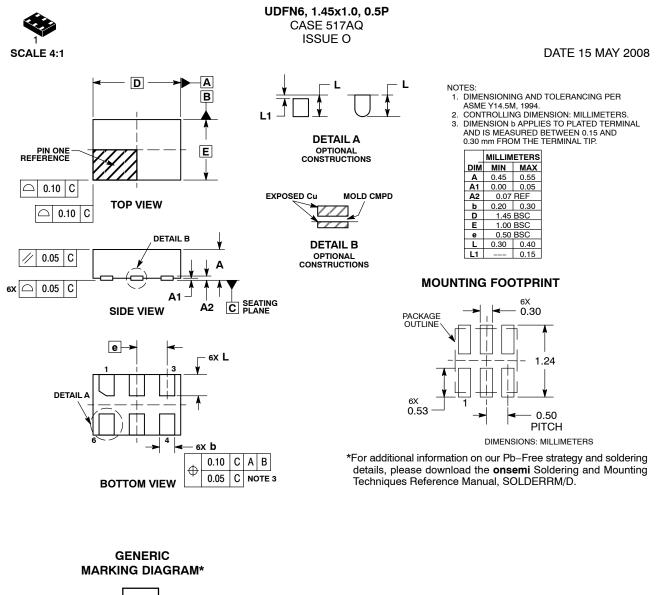
The NLSX4401 has an Enable pin (EN) that provides tri-state operation at the I/O pins. Driving the Enable pin to a low logic level minimizes the power consumption of the device and drives the I/O V_{CC} and I/O V_L pins to a high impedance state. Normal translation operation occurs when the EN pin is equal to a logic high signal. The EN pin is referenced to the V_L supply and has Overvoltage Tolerant (OVT) protection.

Power Supply Guidelines

During normal operation, supply voltage V_L can be greater than, less than or equal to V_{CC} . The sequencing of the power supplies will not damage the device during the power up operation.

For optimal performance, 0.01 μ F to 0.1 μ F decoupling capacitors should be used on the V_{CCA} and V_{CCB} power supply pins. Ceramic capacitors are a good design choice to filter and bypass any noise signals on the voltage lines to the ground plane of the PCB. The noise immunity will be maximized by placing the capacitors as close as possible to the supply and ground pins, along with minimizing the PCB connection traces.





XM

= Specific Device Code

Х

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " .", may or may not be present.

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